

STGW35NC120HD

32 A - 1200 V - very fast IGBT

Features

- Low on-losses
- Low on-voltage drop (V_{CE(sat)})
- High current capability
- High input impedance (voltage driven)
- Low gate charge
- Ideal for soft switching application

Application

- Induction heating
- High frequency inverters
- UPS

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

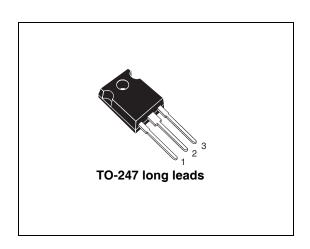


Figure 1. Internal schematic diagram

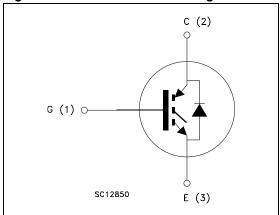


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW35NC120HD	GW35NC120HD	TO-247 long leads	Tube

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STGW35NC120HD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	60	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	32	Α
I _{CL} (2)	Turn-off latching current	135	Α
I _{CP} (3)	Pulsed collector current	135	Α
V _{GE}	Gate-emitter voltage	±25	V
P _{TOT}	Total dissipation at T _C = 25 °C	235	W
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM} Surge non repetitive forward current t _p = 10 ms sinusoidal		100	Α
Tj	Operating junction temperature	-55 to 150	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V_{CES}, T_j =125 °C, R_G=10 Ω , V_{GE}=15 V
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Thermal resistance junction-case IGBT 0.53		0.53	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb} Thermal resistance junction-ambient 50		50	°C/W

2 Electrical characteristics

(T $_j$ =25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	1200			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A, V _{GE} = 15 V, I _C = 20 A, T _j =125 °C		2.2 2.0	2.75	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250\mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} =1200 V V _{CE} =1200 V, T _j =125 °C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9 _{fs} ⁽¹⁾	Forward transconductance	V _{CE} = 25 V _, I _C = 20 A		14		S

^{1.} Pulse duration = 300 μs, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0	-	2510 175 30	1	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V	-	110 16 49	1	nC nC nC



Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17	-	29 11 1820	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 960 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_j = 125 \text{ °C } Figure 17$	-	27 14 1580	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17	-	90 275 312	-	ns ns ns
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{j} = 125 \text{ °C}$ Figure 17	-	150 336 592	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17	1	1660 4438 6098	1	고 고 고
Eon ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{j} = 125 \text{ °C}$ Figure 17	-	3015 6900 9915	-	돈 돈 돈

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A	_	1.9	2.5	V
٧F	Torward on voltage	$I_F = 20 \text{ A}, T_C = 125 ^{\circ}\text{C}$		1.7		V
t _{rr}	Reverse recovery time	$I_F = 20 \text{ A}, V_R = 27 \text{ V},$		152		ns
Q_{rr}	Reverse recovery charge	$T_j = 125 ^{\circ}\text{C}$, di/dt = 100 A/ μ s	-	722	-	nC
I _{rrm}	Reverse recovery current	Figure 20		9		Α

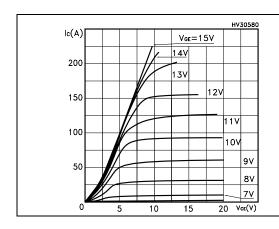
^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW35NC120HD

Electrical characteristics (curves) 2.1

Figure 2. **Output characteristics**

Figure 3. **Transfer characteristics**



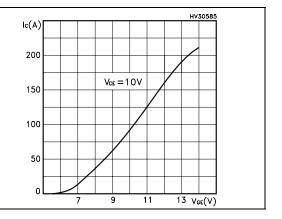
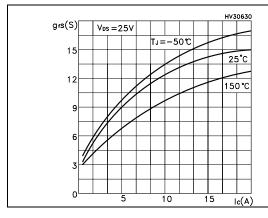


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



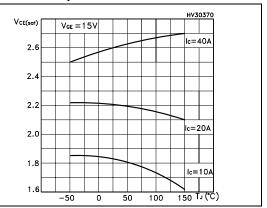
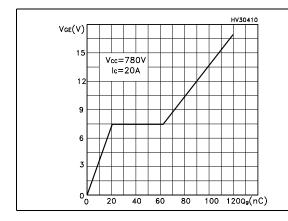
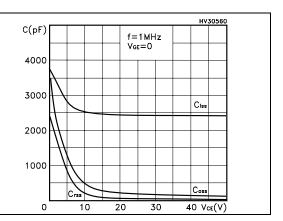


Figure 6. Gate charge vs. gate-source voltage Figure 7. **Capacitance variations**



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Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs. vs. temperature collector current

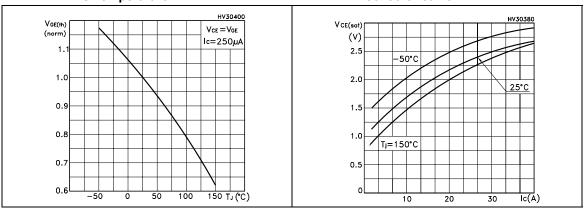


Figure 10. Normalized breakdown voltage vs. Figure 11. Switching losses vs. temperature temperature

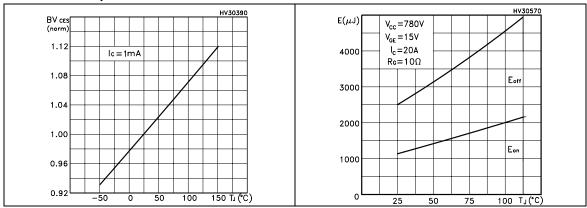
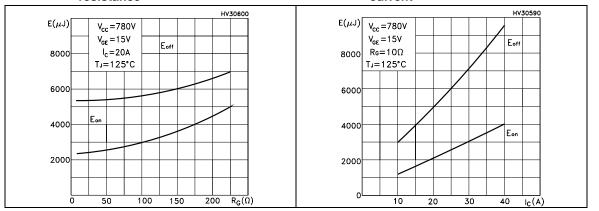


Figure 12. Switching losses vs. gate resistance

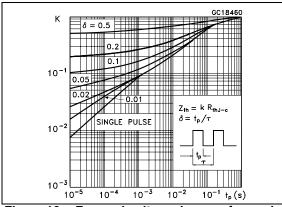
Figure 13. Switching losses vs. collector current



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Figure 14. Thermal Impedance

Figure 15. Reverse biased SOA



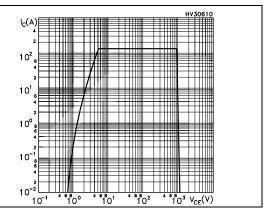
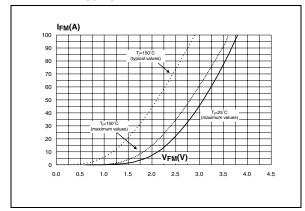


Figure 16. Forward voltage drop vs. forward current



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STGW35NC120HD Test circuits

3 Test circuits

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

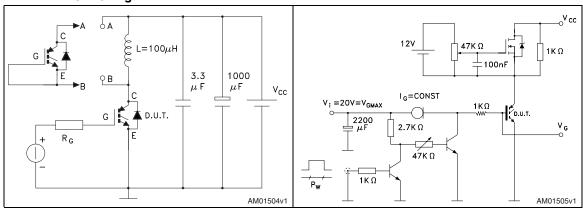
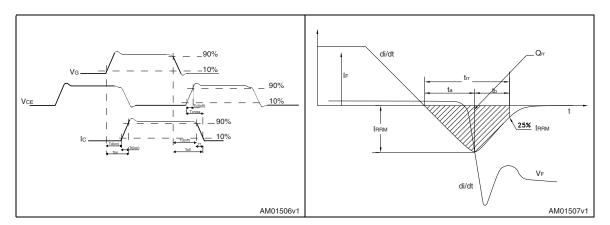


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform



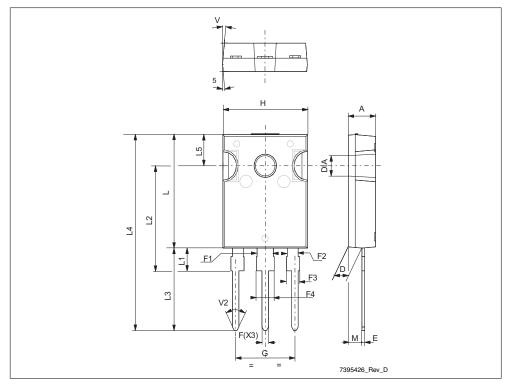
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

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Di-		mm	
Dim.	Min.	Тур.	Max.
A	4.85		5.16
D	2.2		2.6
Е	0.4		0.8
F	1		1.4
F1		3	
F2		2	
F3	1.9		2.4
F4	3		3.4
G		10.9	
Н	15.45		16.03
L	19.85		21.09
L1	3.7		4.3
L2	18.3		19.13
L3	14.2		20.3
L4	34.05		41.38
L5	5.35		6.3
М	2		3
V		5°	
V2		60°	
DIAM	3.55		3.65



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Revision history STGW35NC120HD

5 Revision history

Table 9. Document revision history

Date	Revision	Changes	
25-Jan-2008	1	First issue.	
07-May-2009	2	Section 4: Package mechanical data has been updated.	

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